

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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1A, 200V - 1000V Surface Mount Fast Recovery Rectifier

FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Low profile package
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

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- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in computer, automotive and telecommunication

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- Case: SOD-128
- Molding compound meets UL 94V-0 flammability rating
- Part no. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.027 g (approximately)

KEY PARAMETERS							
PARAMETER VALUE UN							
I _{F(AV)}	1	Α					
V_{RRM}	200 - 1000	٧					
I _{FSM}	30	Α					
T _{J MAX}	MAX 150						
Package	SOD-128						
Configuration	Single die						





SOD-128

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)							T
PARAMETER	SYMBOL	RS1DFS	RS1GFS	RS1JFS	RS1KFS	RS1MFS	UNIT
Marking code on the device		RS1DFS	RS1GFS	RS1JFS	RS1KFS	RS1MFS	
Repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	140	280	420	560	700	V
Forward current	I _{F(AV)}			1			Α
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I _{FSM}	30			А		
Junction temperature	T_J	- 55 to +150			°C		
Storage temperature	T _{STG}	- 55 to +150				°C	

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THERMAL PERFORMANCE								
PARAMETER	SYMBOL	LIMIT	UNIT					
Junction-to-lead thermal resistance per diode	$R_{\Theta JL}$	29	°C/W					
Junction-to-ambient thermal resistance per diode	$R_{\Theta JA}$	84	°C/W					
Junction-to-case thermal resistance per diode	R _{eJC}	30	°C/W					

Thermal Performance Note: Units mounted on recommended PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)								
PARAMETER		CONDITIONS SYMBOL		TYP	мах	UNIT		
		$I_F = 0.5A, T_J = 25^{\circ}C$		0.94	1.10			
	$I_F = 1.0A, T_J = 25^{\circ}C$	V _F	1.01	1.30	V			
Forward voltage per diode (1)	$I_F = 0.5A, T_J = 125^{\circ}C$		0.79	1.00				
	I _F = 1.0A, T _J = 125°C		0.88	1.20				
Developed Overland V. on	T _J = 25°C	I _R	-	5	μΑ			
Reverse current ω rated v_R p	Reverse current @ rated V _R per diode ⁽²⁾			-	50	μΑ		
Junction capacitance	Junction capacitance			7	-	pF		
	RS1DFS RS1GFS		t _{rr}	-	150	ns		
Reverse recovery time	RS1JFS	I _F =0.5A ,I _R =1.0A		-	250	ns		
	RS1KFS RS1MFS	- I _{RR} =0.25A		-	500	ns		

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION							
PART NO.	PART NO. SUFFIX(*)	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING		
RS1xFS	Н	MW	G	SOD-128	3,500 / 7" Plastic reel		
(Note 1, 2)		MX	G	SOD-128	14,000 / 13" Plastic reel		

Notes:

- 1. "xx" defines voltage from 200V (RS1DFS) to 1000V (RS1MFS)
- 2. Whole series with green compound (halogen-free)
- *: Optional available

EXAMPLE P/N								
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION			
RS1DFSHMWG	RS1DFS	Н	MW	G	AEC-Q101 qualified Green compound			

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CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

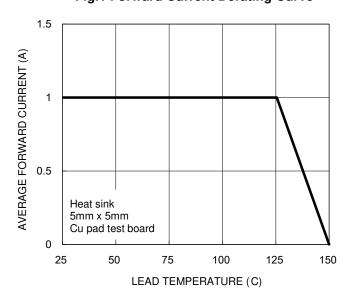


Fig.2 Typical Junction Capacitance

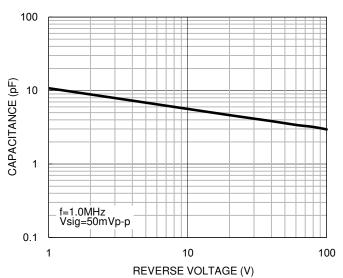


Fig.3 Typical Reverse Characteristics

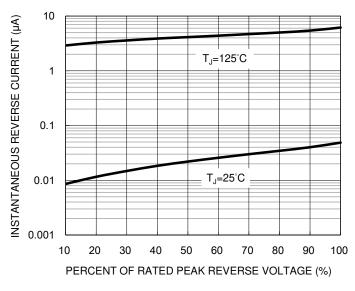
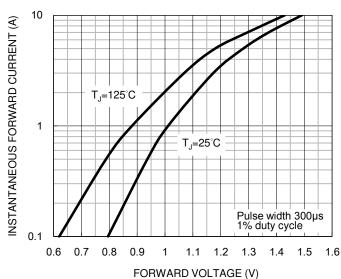


Fig.4 Typical Forward Characteristics

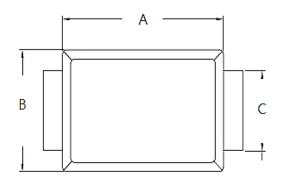




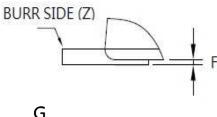


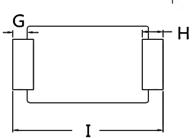
PACKAGE OUTLINE DIMENSIONS

SOD-128



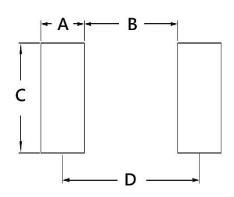






Unit (mm) Unit (inch) DIM Min Max Min Max 4.00 0.142 Α 3.60 0.157 В 2.30 2.70 0.091 0.106 С 1.60 1.90 0.063 0.075 D 0.90 1.10 0.035 0.043 Ε 0.10 0.22 0.004 0.009 F 0.00 0.10 0.000 0.004 G 0.30 0.60 0.012 0.024 Н 0.40 0.80 0.016 0.031 ı 4.40 5.00 0.173 0.197

SUGGESTED PAD LAYOUT



DIM	Unit (mm)	Unit (inch)
Α	1.40	0.055
В	3.00	0.118
С	2.10	0.082
D	4.40	0.173

MARKING DIAGRAM



P/N = Marking Code YW = Date Code F = Factory Code



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